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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/709,664	05/21/2004	Min-Hsun Hsieh	KYCP0009USA1 3663		
27765	7590 02/24/2006		EXAMINER		
NORTH AMERICA INTELLECTUAL PROPERTY CORPORATION			DANG, TRUNG Q		
	P.O. BOX 506 MERRIFIELD, VA 22116		ART UNIT	PAPER NUMBER	
			2823		
		DATE MAILED: 02/24/2000	5		

Please find below and/or attached an Office communication concerning this application or proceeding.

Advisory Action Before the Filing of an Appeal Brief

Application No.	Applicant(s)	
10/709,664	HSIEH ET AL.	
Examiner	Art Unit	- <u>-</u> -
Trung Dang	2823	

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	Trung Dang	2823	
The MAILING DATE of this communication appe	ears on the cover sheet with the o	correspondence add	ress
THE REPLY FILED 20 January 2006 FAILS TO PLACE THIS A			
1. The reply was filed after a final rejection, but prior to or or this application, applicant must timely file one of the follow places the application in condition for allowance; (2) a Not a Request for Continued Examination (RCE) in compliant time periods:	wing replies: (1) an amendment, af otice of Appeal (with appeal fee) in	fidavit, or other evider compliance with 37 C	nce, which FR 41.31; or (3)
a) The period for reply expires 3 months from the mailing date			
b) The period for reply expires on: (1) the mailing date of this A no event, however, will the statutory period for reply expire	later than SIX MONTHS from the mailin	g date of the final reject	ion.
Examiner Note: If box 1 is checked, check either box (a) or TWO MONTHS OF THE FINAL REJECTION. See MPEP 7	'06.07(f).		
Extensions of time may be obtained under 37 CFR 1.136(a). The date have been filed is the date for purposes of determining the period of exunder 37 CFR 1.17(a) is calculated from: (1) the expiration date of the set forth in (b) above, if checked. Any reply received by the Office late may reduce any earned patent term adjustment. See 37 CFR 1.704(b) NOTICE OF APPEAL	ctension and the corresponding amount shortened statutory period for reply orig to than three months after the mailing da	of the fee. The appropr inally set in the final Off	iate extension fee ice action; or (2) as
2. The Notice of Appeal was filed on A brief in comp	pliance with 37 CFR 41 37 must be	filed within two month	ns of the date of
filing the Notice of Appeal (37 CFR 41.37(a)), or any external a Notice of Appeal has been filed, any reply must be filed	ension thereof (37 CFR 41.37(e)), to	o avoid dismissal of the	ne appeal. Since
AMENDMENTS			
The proposed amendment(s) filed after a final rejection,			ecause
(a) They raise new issues that would require further co		I E below);	
 (b) They raise the issue of new matter (see NOTE below) (c) They are not deemed to place the application in be appeal; and/or 		ducing or simplifying	the issues for
(d) They present additional claims without canceling a		ected claims.	
NOTE: (See 37 CFR 1.116 and 41.33(a)).		mpliant Amandment	(DTOL.324)
4. The amendments are not in compliance with 37 CFR 1.1		Milphant Amendment	(F10L-324).
5. Applicant's reply has overcome the following rejection(s)6. Newly proposed or amended claim(s) would be a		timely filed amendme	ent canceling the
non-allowable claim(s).			
 For purposes of appeal, the proposed amendment(s): a) how the new or amended claims would be rejected is pro 		II be entered and an	explanation of
The status of the claim(s) is (or will be) as follows: Claim(s) allowed:			
Claim(s) anowed: Claim(s) objected to:			
Claim(s) rejected:			
Claim(s) withdrawn from consideration:			
AFFIDAVIT OR OTHER EVIDENCE B. ☐ The affidavit or other evidence filed after a final action, but	ut hoforo or on the date of filing a N	otice of Appeal will re	nt he entered
because applicant failed to provide a showing of good ar was not earlier presented. See 37 CFR 1.116(e).	nd sufficient reasons why the affida	vit or other evidence i	s necessary and
9. The affidavit or other evidence filed after the date of filing entered because the affidavit or other evidence failed to showing a good and sufficient reasons why it is necessar	overcome <u>all</u> rejections under appe ry and was not earlier presented. S	al and/or appellant fa See 37 CFR 41.33(d)(ils to provide a 1).
10. ☐ The affidavit or other evidence is entered. An explanation REQUEST FOR RECONSIDERATION/OTHER	on of the status of the claims after e	entry is below or attac	hed.
11. The request for reconsideration has been considered be See Continuation Sheet.	ut does NOT place the application i	n condition for allowa	nce because:
12. Note the attached Information Disclosure Statement(s).	(PTO/SB/08 or PTO-1449) Paper I	No(s). <u>2/10/06</u>	
13.	•		
	•	Trung Bang	λ·
			J
		Primary Examiner	

Art Unit: 2823

Continuation of 11. does NOT place the application in condition for allowance because: In page 3 of the Remarks, applicants argue that " ... we can conclude that Yamazaki never teaches holding the transparent conductive layer 20 and the substrate 10 together with the metal thin layer 15, or bonding together the transparent conductive layer 20 and the metal thin layer 15 of the substrate 10. The transparent conductive layer 20 is just formed on the metal thin layer 15 by sputtering, not by bonding. Therefore, Yamazaki's metal thin layer used to enhance the adhesive properties of sputtering is not analogous to Yang's adhesion promoter provided by BCB bondings, and it would not be obvious to one skilled in the art to combine these two teachings." The Examiner respectfully disagrees. It is the reference to Yang, not Yamazaki, that is employed in the rejection to show the teaching of using an adhesion promoter layer for improving the adhesion property between the LED epitaxial structure and the transparent substrate which are bonded together by a transparent adhesive layer 14 of BCB or epoxy (col. 4, lines 1-6 and Fig.3 in Yang). What Yang lacks is the material of the adhesion promoter layer 14. However, the deficiency in Yang is provided by Yamazaki's teaching. That is, a metal material such as Ti or Cr is taught to enhance the adhesion property between a transparent substrate and an ITO transparent conductive layer (para. [0068]). Accordingly, Yamazaki' teaching provides motivation as to why one of ordinary skill in the art would select Ti or Cr for the adhesion promoter layer. It is noted that the combined process of Lebby and Yang results in the formation of the adhesion promoter layers on the surface of the LED first stack (i.e., on the ITO transparent conductive layer 20 depicted in Fig. 3 of Lebby) and on the surface of the transparent substrate 25 (i.e., between the transparent substrate 25 and the transparent adhesive layer 22). That is, the adhesion promoter enhances the adhesion property between the transparent substrate and the ITO layer 20. Such feature is within the context of Yamazaki's teaching, hence combining the two references of Yang and Yamazaki is relevant.

The information disclosure statement (IDS) submitted on 2/10/06 was filed after the mailing date of the final Office action on 11/15/05. The submission is in compliance with the provisions of 37 CFR 1.97. Accordingly, the information disclosure statement is being considered by the examiner.